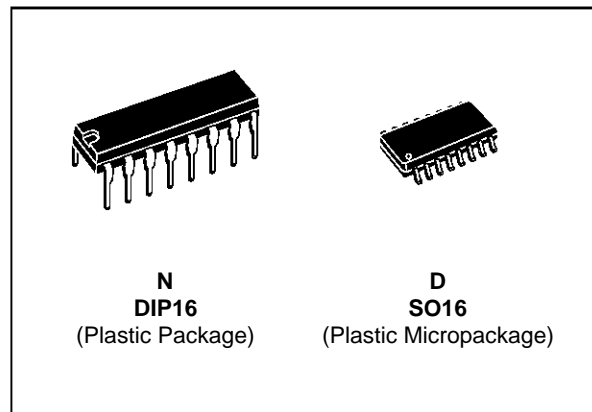


3V INPUT/OUTPUT RAIL TO RAIL QUAD OPERATIONAL AMPLIFIER (WITH STANDBY POSITION)

- DEDICATED TO 3.3V OR BATTERY SUPPLY (specified at 3V and 5V)
- **RAIL TO RAIL** INPUT AND OUTPUT VOLTAGE RANGES
- 2 SEPARATE **STANDBY** : REDUCED CONSUMPTION AND HIGH IMPEDANCE OUTPUTS
- SINGLE (OR DUAL) SUPPLY OPERATION FROM 2.7V TO 16V
- EXTREMELY LOW INPUT BIAS CURRENT : **1pA** TYP
- LOW INPUT OFFSET VOLTAGE : 5mV max.
- SPECIFIED FOR **600Ω** AND **150Ω** LOADS
- LOW SUPPLY CURRENT : 200μA/Ampli



ORDER CODES

Part Number	Temperature Range	Package	
		N	D
TS3V904I/AI	-40, +125°C	•	•

DESCRIPTION

The TS3V904 is a RAIL TO RAIL quad CMOS operational amplifier designed to operate with a single 3V supply voltage.

The input voltage range V_{icm} includes the two supply rails V_{CC}^+ and V_{CC}^- .

The output reaches :

- $V_{CC}^- +50mV$ $V_{CC}^+ -50mV$ with $R_L = 10k\Omega$
- $V_{CC}^- +350mV$ $V_{CC}^+ -350mV$ with $R_L = 600\Omega$

This product offers a broad supply voltage operating range from 2.7V to 16V and a supply current of only 200μA/amp. ($V_{CC} = 3V$)

Source and sink output current capability is typically 40mA (at $V_{CC} = 3V$), fixed by an internal limitation circuit.

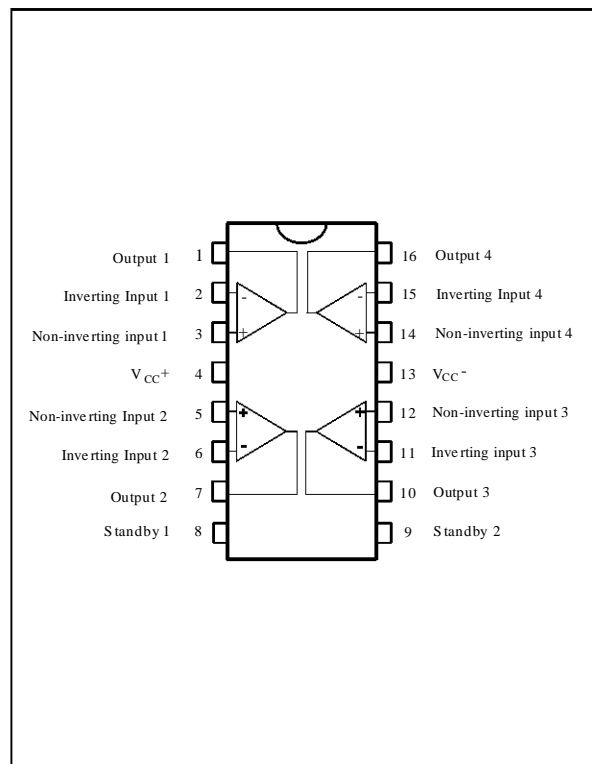
The TS3V904 offers two separate **STANDBY** pins

- STANDBY 1 acting on the n°2 and n°3 operators
- STANDBY 2 acting on the n°1 and n°4 operators

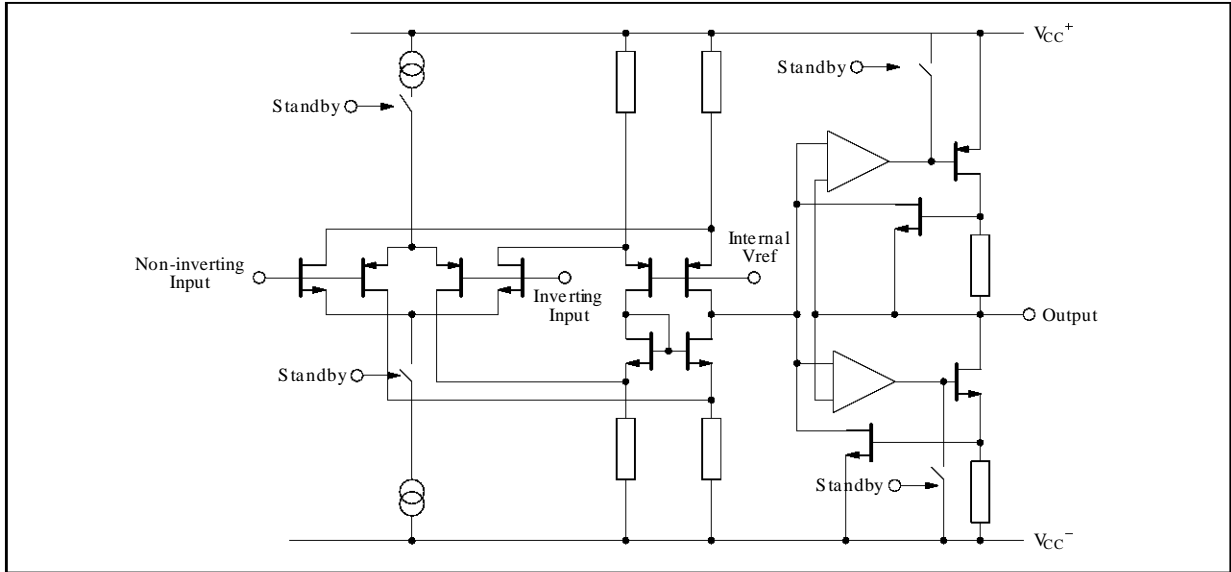
They reduce the consumption of the corresponding operators and put the outputs in a high impedance state.

These two STANDBY pins should never stay not connected.

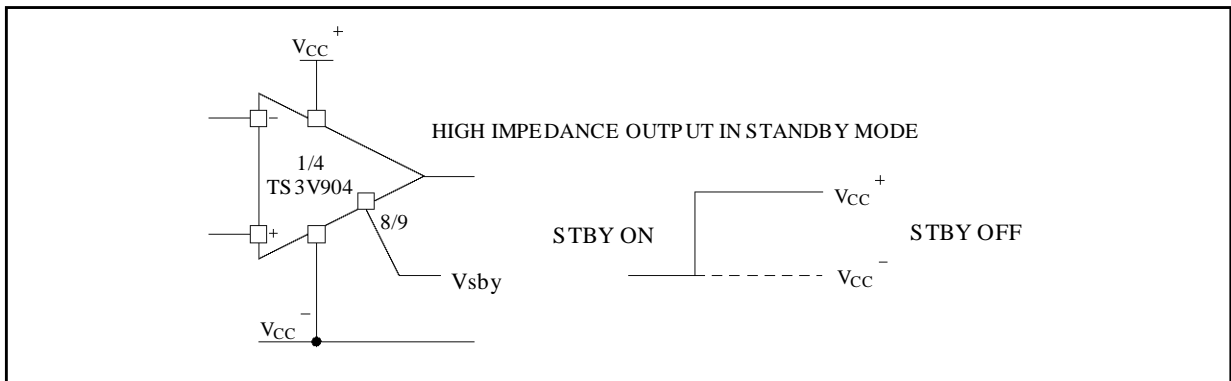
PIN CONNECTIONS (top view)



SCHEMATIC DIAGRAM (1/4 TS3V904)



STANDBY POSITION



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage - (note 1)	18	V
V_{id}	Differential Input Voltage - (note 2)	± 18	V
V_i	Input Voltage - (note 3)	-0.3 to 18	V
I_{in}	Current on Inputs	± 50	mA
I_o	Current on Outputs	± 130	mA
T_{oper}	Operating Free Air Temperature Range	TS3V904/AI -40 to +125	$^{\circ}C$

- Notes :**
1. All voltage values, except differential voltage are with respect to network ground terminal.
 2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
 3. The magnitude of input and output voltages must never exceed $V_{CC}^{+} + 0.3V$.

OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	2.7 to 16	V
V_{icm}	Common Mode Input Voltage Range	$V_{CC}^{-} - 0.2$ to $V_{CC}^{+} + 0.2$	V

ELECTRICAL CHARACTERISTICS

$V_{CC}^+ = 3V$, $V_{CC}^- = 0V$, R_L, C_L connected to $V_{CC}/2$, pin 8 and pin 9 connected to V_{CC}^+ , $T_{amb} = 25^\circ C$
(unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage ($V_{ic} = V_o = V_{CC}/2$) $T_{min.} \leq T_{amb} \leq T_{max.}$			10 5 12 7	mV
DV_{io}	Input Offset Voltage Drift		5		$\mu V/^\circ C$
I_{io}	Input Offset Current - (note 1) $T_{min.} \leq T_{amb} \leq T_{max.}$		1	100 200	pA
I_{ib}	Input Bias Current - (note 1) $T_{min.} \leq T_{amb} \leq T_{max.}$		1	150 300	pA
I_{CC}	Supply Current (per amplifier, $A_{VCL} = 1$, no load) $T_{min.} \leq T_{amb} \leq T_{max.}$		200	300 400	μA
CMR	Common Mode Rejection Ratio $V_{ic} = 0$ to $3V$, $V_o = 1.5V$	40	70		dB
SVR	Supply Voltage Rejection Ratio ($V_{CC}^+ = 2.7$ to $3.3V$, $V_o = V_{CC}/2$)	40	70		dB
A_{vd}	Large Signal Voltage Gain ($R_L = 10k\Omega$, $V_o = 1.2V$ to $1.8V$) $T_{min.} \leq T_{amb} \leq T_{max.}$	3 2	10		V/mV
V_{OH}	High Level Output Voltage ($V_{id} = 1V$) $T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$	2.9 2.3 2.8 2.1	2.96 2.6 2	V
V_{OL}	Low Level Output Voltage ($V_{id} = -1V$) $T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$ $R_L = 10k\Omega$ $R_L = 600\Omega$		50 300 900 150 600	mV
I_o	Output Short Circuit Current ($V_{id} = \pm 1V$) Source ($V_o = V_{CC}^-$) Sink ($V_o = V_{CC}^+$)		40 40		mA
GBP	Gain Bandwidth Product ($A_{VCL} = 100$, $R_L = 10k\Omega$, $C_L = 100pF$, $f = 100kHz$)		0.8		MHz
SR^+	Positive Slew Rate ($A_{VCL} = 1$, $R_L = 10k\Omega$, $C_L = 100pF$, $V_i = 1.3V$ to $1.7V$)		0.5		V/ μs
SR^-	Negative Slew Rate ($A_{VCL} = 1$, $R_L = 10k\Omega$, $C_L = 100pF$, $V_i = 1.3V$ to $1.7V$)		0.4		V/ μs
ϕ_m	Phase Margin		30		Degrees
e_n	Equivalent Input Noise Voltage ($R_s = 100\Omega$, $f = 1kHz$)		30		$\frac{nV}{\sqrt{Hz}}$
V_{O1}/V_{O2}	Channel Separation ($f = 1kHz$)		120		dB

Note 1 : Maximum values including unavoidable inaccuracies of the industrial test.

STANDBY MODE

$V_{CC}^+ = 3V$, $V_{CC}^- = 0V$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	TS3V904I/AI			Unit
		Min.	Typ.	Max.	
$V_{in\ SBY/ON}$	Pin 8/9 Threshold Voltage for STANDBY ON		1.2		V
$V_{in\ SBY/OFF}$	Pin 8/9 Threshold Voltage for STANDBY OFF		1.5		V
$I_{CC\ SBY}$	Total Consumption Standby 1 ON - Standby 2 OFF Standby 1 OFF - Standby 2 ON Standby 1 and 2 ON		400 400 0.5		μA

ELECTRICAL CHARACTERISTICS

$V_{CC}^+ = 5V$, $V_{CC}^- = 0V$, R_L, C_L connected to $V_{CC}/2$, pin 8 and pin 9 connected to V_{CC}^+ , $T_{amb} = 25^\circ C$
(unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input Offset Voltage ($V_{ic} = V_o = V_{CC}/2$) $T_{min.} \leq T_{amb} \leq T_{max.}$			10 5 12 7	mV
DV_{io}	Input Offset Voltage Drift		5		$\mu V/^\circ C$
I_{io}	Input Offset Current - (note 1) $T_{min.} \leq T_{amb} \leq T_{max.}$		1	100 200	pA
I_{ib}	Input Bias Current - (note 1) $T_{min.} \leq T_{amb} \leq T_{max.}$		1	150 300	pA
I_{CC}	Supply Current (per amplifier, $A_{VCL} = 1$, no load) $T_{min.} \leq T_{amb} \leq T_{max.}$		230	350 450	μA
CMR	Common Mode Rejection Ratio $V_{ic} = 1.5$ to $3.5V$, $V_o = 2.5V$	50	75		dB
SVR	Supply Voltage Rejection Ratio ($V_{CC}^+ = 3$ to $5V$, $V_o = V_{CC}/2$)	50	80		dB
A_{vd}	Large Signal Voltage Gain ($R_L = 10k\Omega$, $V_o = 1.5V$ to $3.5V$) $T_{min.} \leq T_{amb} \leq T_{max.}$	10 7	30		V/mV
V_{OH}	High Level Output Voltage ($V_{id} = 1V$) $T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 10k\Omega$ 4.9 $R_L = 600\Omega$ 4.25 $R_L = 100\Omega$	4.95 4.65 3.7		V
V_{OL}	Low Level Output Voltage ($V_{id} = -1V$) $T_{min.} \leq T_{amb} \leq T_{max.}$	$R_L = 10k\Omega$ $R_L = 600\Omega$ $R_L = 100\Omega$	50 350 1400	100 500	mV
I_o	Output Short Circuit Current ($V_{id} = \pm 1V$)	Source ($V_o = V_{CC}^-$) 45 Sink ($V_o = V_{CC}^+$) 45	60 60		mA
GBP	Gain Bandwidth Product ($A_{VCL} = 100$, $R_L = 10k\Omega$, $C_L = 100pF$, $f = 100kHz$)		0.9		MHz
SR^+	Positive Slew Rate ($A_{VCL} = 1$, $R_L = 10k\Omega$, $C_L = 100pF$, $V_i = 1V$ to $4V$)		0.8		V/ μs
SR^-	Negative Slew Rate ($A_{VCL} = 1$, $R_L = 10k\Omega$, $C_L = 100pF$, $V_i = 1V$ to $4V$)		0.5		V/ μs
ϕ_m	Phase Margin		30		Degrees

Note 1 : Maximum values including unavoidable inaccuracies of the industrial test.

TYPICAL CHARACTERISTICS

(standby OFF = standby 1 and 2 OFF)
 (standby ON = standby 1 and 2 ON)

Figure 1a : Supply Current (each amplifier) versus Supply Voltage

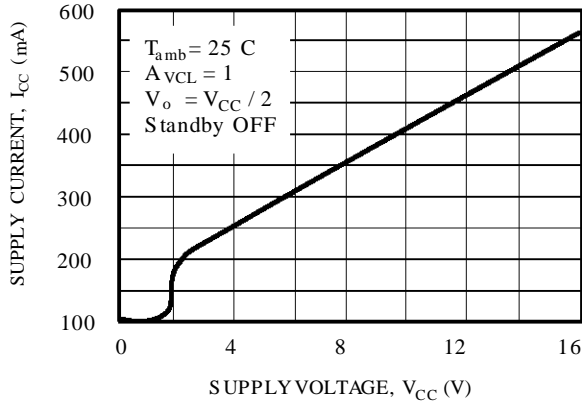


Figure 1b : Supply Current (each amplifier) versus Supply Voltage (in STANDBY)

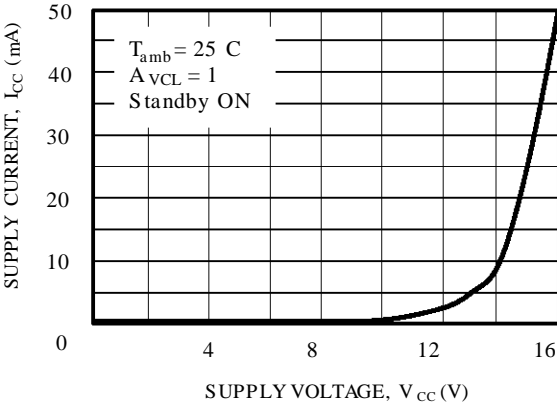


Figure 2 : Input Bias Current versus Temperature

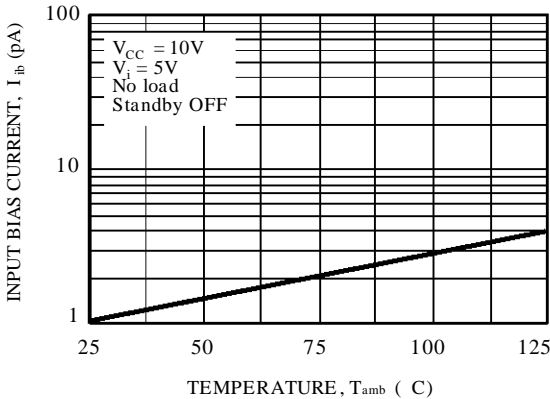


Figure 3a : High Level Output Voltage versus High Level Output Current

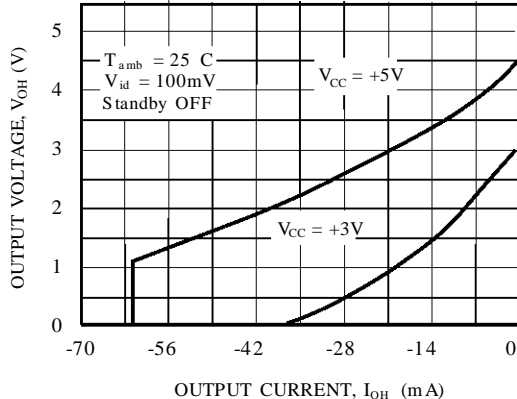


Figure 3b : High Level Output Voltage versus High Level Output Current

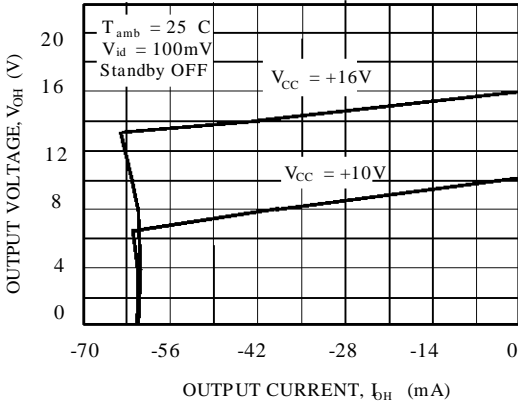


Figure 4a : Low Level Output Voltage versus Low Level Output Current

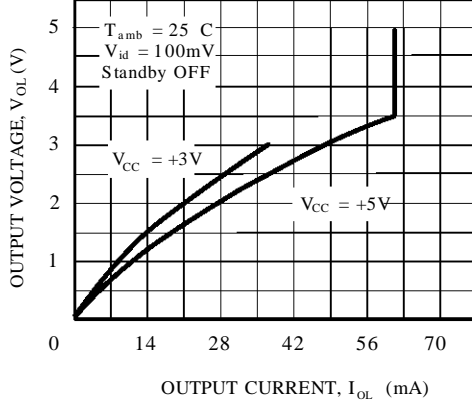


Figure 4b : Low Level Output Voltage versus Low Level Output Current

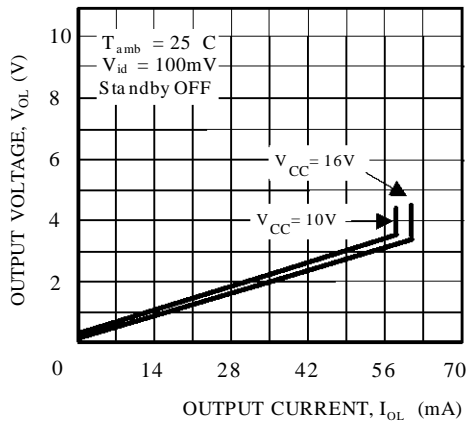


Figure 5a : Open Loop Frequency Response and Phase Shift

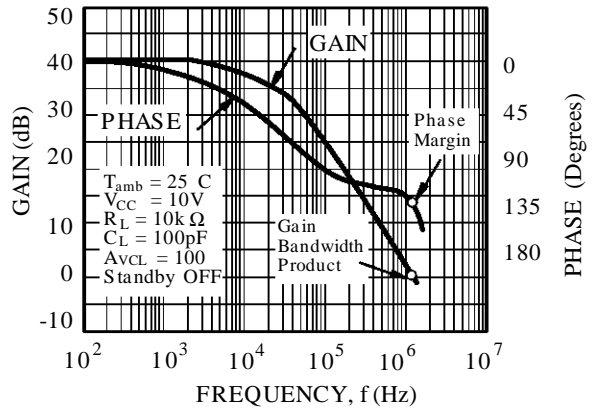


Figure 5b : Open Loop Frequency Response and Phase Shift

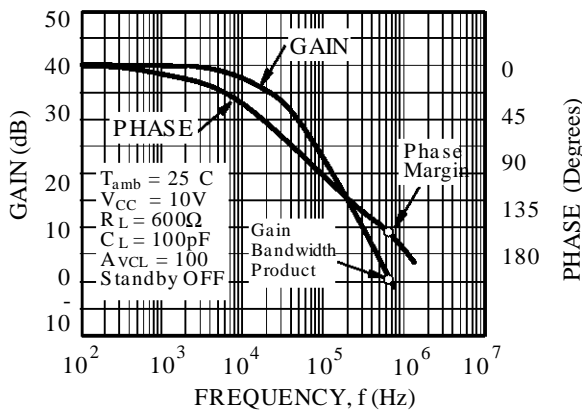


Figure 6a : Gain Bandwidth Product versus Supply Voltage

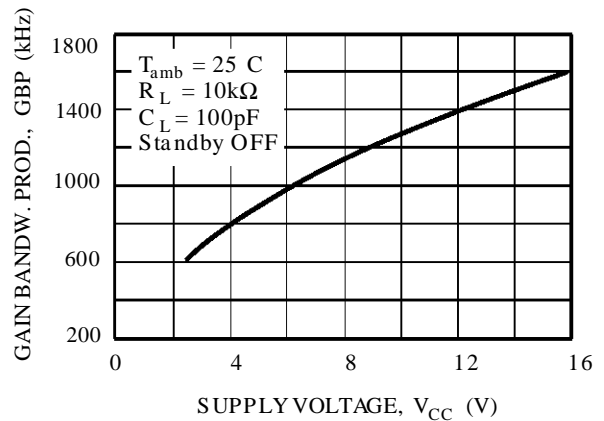


Figure 6b : Gain bandwidth Product versus Supply Voltage

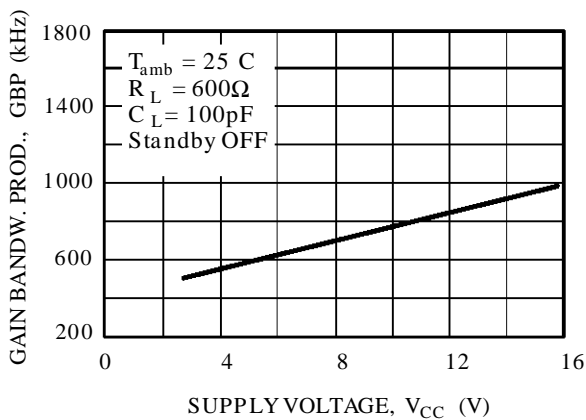


Figure 7a : Phase Margin versus Supply Voltage

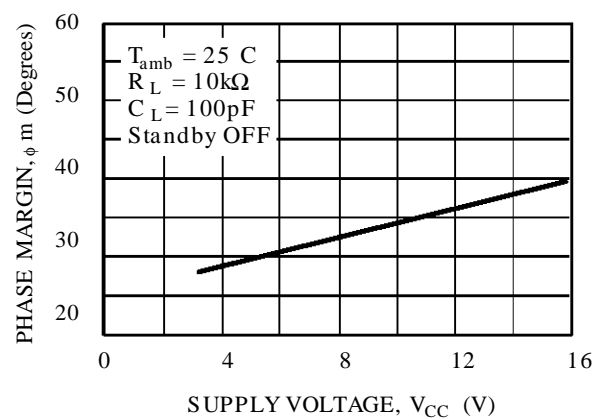


Figure 7b : Phase Margin versus Supply Voltage

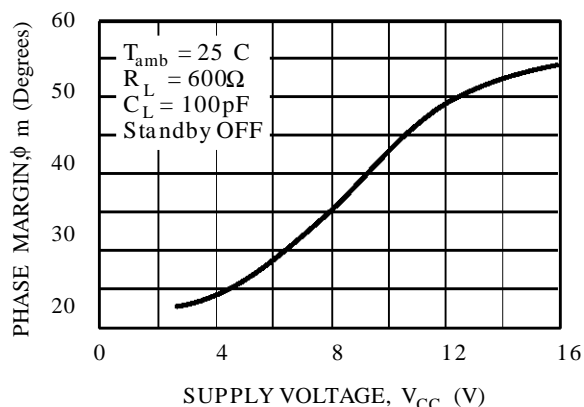
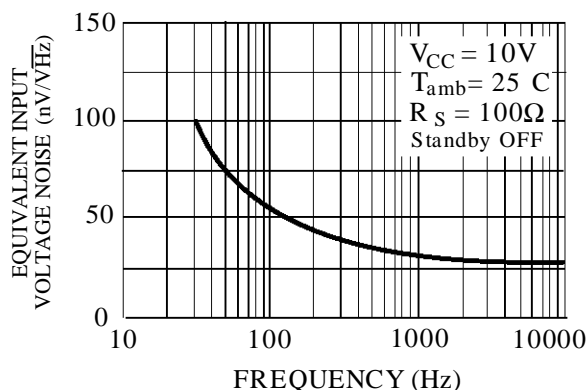


Figure 8 : Input Voltage Noise versus Frequency



STANDBY APPLICATION

The TS3V904 offers two separate STANDBY pins :

- **STANDBY 1** (pin 8) acting on the n°2 and n°3 operators.
- **STANDBY 2** (pin 9) acting on the n°1 and n°4 operators.

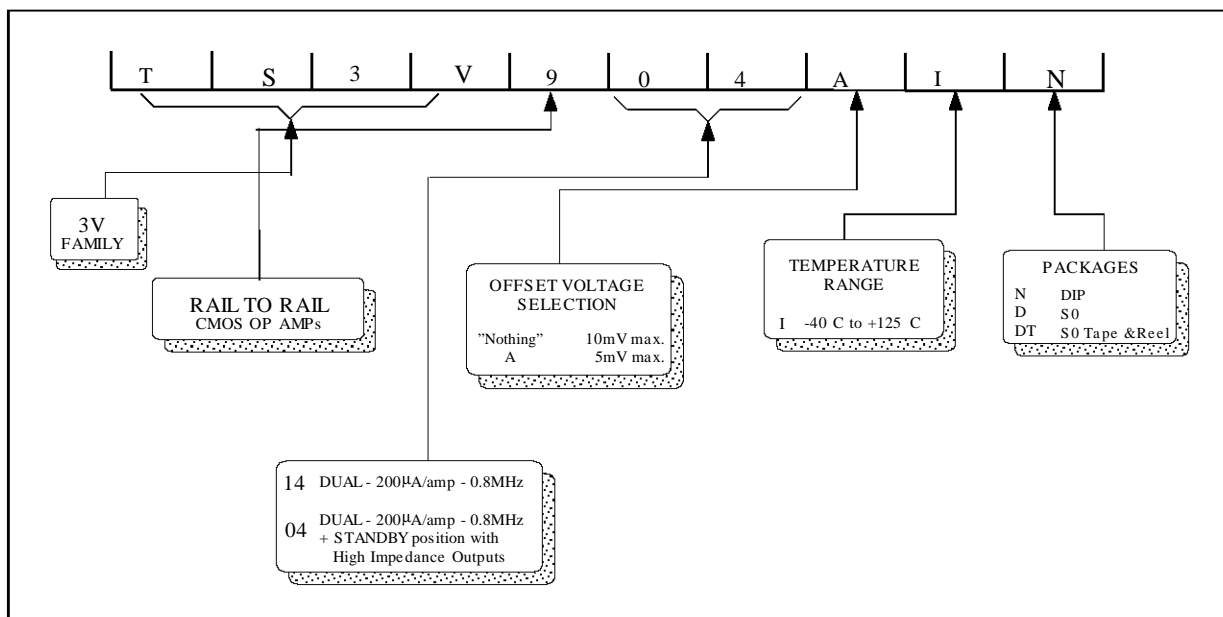
When one of these standby is activated (STANDBY ON) :

- The supply current of the corresponding operators is considerably reduced. The total consumption of the circuit is then divided by 2 (one STANDBY ON) or decreased down to 0.5μA (V_{CC} = 3V, two STANDBY ON). (ref. figure 1b).
- All the outputs of the corresponding operators are in high impedance state. No output current can then be sourced or sinked.

The standby pins 8 and 9 should never stay unconnected.

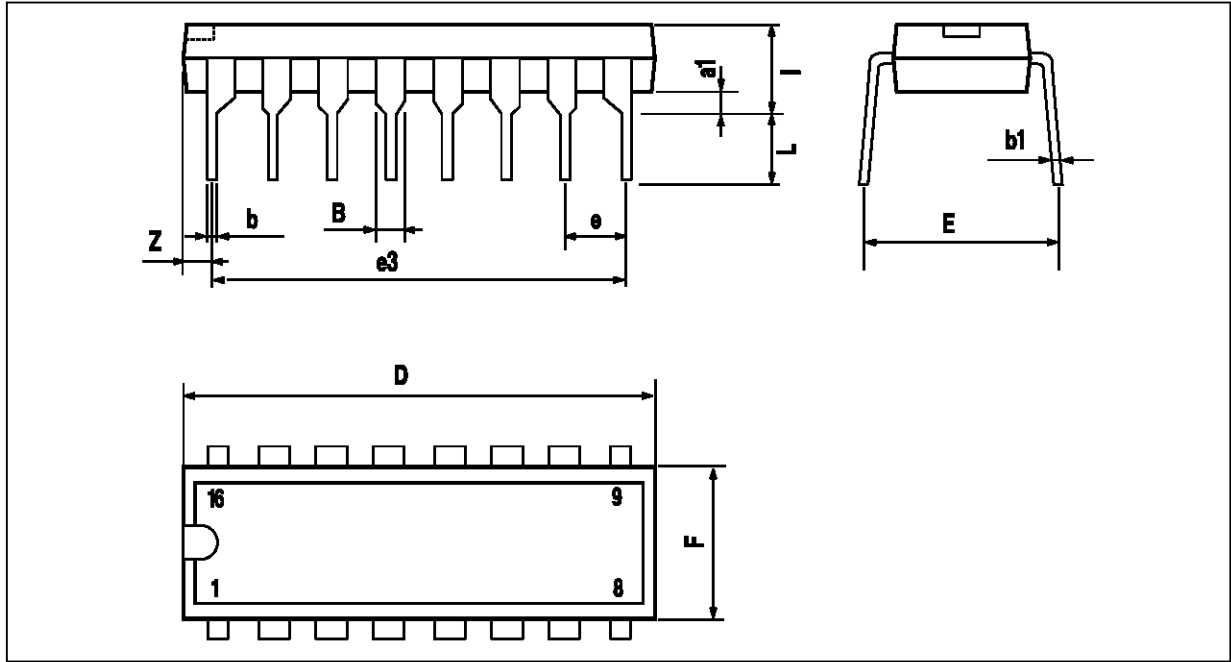
- The "standby OFF" state, is reached when the pins 8 or 9 voltage is **higher than V_{in} SBY/OFF**.
- The "standby ON" state, is assured by the pins 8 or 9 voltage **lower than V_{in} SBY/OFF**. (see electrical characteristics)

ORDERING INFORMATION



TS3V904

PACKAGE MECHANICAL DATA
16 PINS - PLASTIC DIP

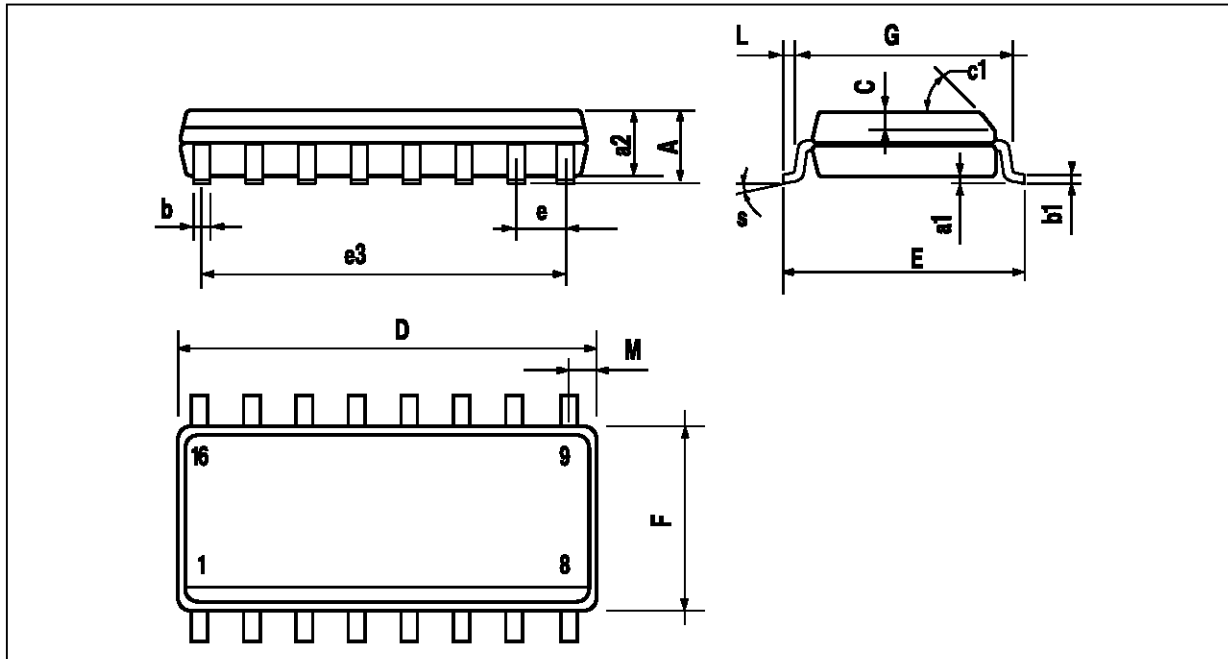


PM-DIP16EPS

Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
a1	0.51			0.020		
B	0.77		1.65	0.030		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		17.78			0.700	
F			7.1			0.280
i			5.1			0.201
L		3.3			0.130	
Z			1.27			0.050

DIP16.TBL

PACKAGE MECHANICAL DATA
 16 PINS - PLASTIC MICROPACKAGE (SO)



PM-SO16.EPS

Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.2	0.004		0.008
a2			1.6			0.063
b	0.35		0.46	0.014		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.020	
c1	45° (typ.)					
D	9.8		10	0.386		0.394
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		8.89			0.350	
F	3.8		4.0	0.150		0.157
G	4.6		5.3	0.181		0.209
L	0.5		1.27	0.020		0.050
M			0.62			0.024
S	8° (max.)					

SO16.TBL

Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specification mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectronics.

© 1996 SGS-THOMSON Microelectronics – Printed in Italy – All Rights Reserved

SGS-THOMSON Microelectronics GROUP OF COMPANIES
 Australia - Brazil - Canada - China - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco
 The Netherlands - Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A.

ORDER CODE :